

# plerow<sup>™</sup> ALN1502AT

## **Internally Matched LNA Module**

## **Features**

- · S<sub>21</sub> = 16.4 dB @ 1500 MHz = 15.4 dB @ 1600 MHz
- NF of 0.65 dB over Frequency
- · Unconditionally Stable
- Single 5V Supply
- · High OIP3 @ Low Current

Parameter

**Frequency Range** 

Gain Flatness

Noise Figure

Output IP3 (1)

S11 / S22 (2)

Output P1dB

Switching Time

Supply Current

Supply Voltage

Impedance

Gain

**Specifications (in Production)** 

## Description

Unit

MHz

dB

dB

dB

dBm

dB

dBm

μsec

mΑ

V

Ω

dBm

mm

The plerow<sup>™</sup> ALN-series is the compactly designed surface-mount module for the use of the LNA with or without the following gain blocks in the infrastructure equipment of the mobile wireless (CDMA, GSM, PCS, PHS, WCDMA, DMB, WLAN, WiBro, WiMAX), GPS, satellite communication terminals, CATV and so on. It has an exceptional performance of low noise figure, high gain, high OIP3, and low bias current. The stability factor is always kept more than unity over the application band in order to ensure its unconditionally stable implementation to the application system environment. The surface-mount module package including the completed matching circuit and other components necessary just in case allows very simple and convenient implementation onto the system board in mass production level.

Typ. @ T = 25°C,  $V_s$  = 5 V, Freq. = 1500 MHz,  $Z_{o.sys}$  = 50 ohm

Min

1400

14.9

25

11

Specifications

Тур

15.9

± 0.5

0.65

26

12

\_

30

5

50

C.W 29 ~ 31 (before fail)

Surface Mount Type, 10Wx10Lx3.8H

Max

1600

± 0.7

0.70

-18 / -10

35







1-stage Single Type

#### More Information

Website: www.asb.co.kr E-mail: sales@asb.co.kr

Tel: (82) 42-528-7223 Fax: (82) 42-528-7222

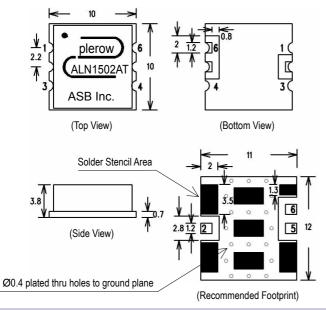
ASB Inc., 4th FI. Venture Town Bldg., 367-17 Goijeong-Dong, Seo-Gu, Daejon 302-716, Korea

Package Type & Size Operating temperature is -40°C to +85°C.

Max. RF Input Power

1) OIP3 is measured with two toes at an output power of 0 dBm / tone separated by 1 MHz.
2) S11/S22 (max) is the worst value within the frequency band.
3) Switching time means the time that takes for output power to get stabilized to its final level after switching DC voltage from 0 V to V<sub>S</sub>.

## **Outline Drawing (Unit: mm)**



Pin Number	Function		
2	RF In		
5	RF Out		
6	+Vcc		
Others	Ground		

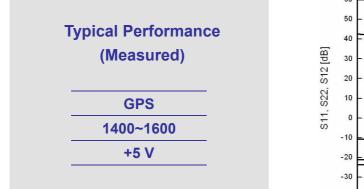
Note: 1. The number and size of ground via holes in a circuit board is critical for thermal RF

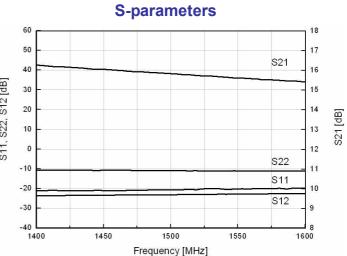
grounding considerations. 2. We recommend that the ground via holes be placed on the bottom of all ground pins for better RF and thermal performance, as shown in the drawing at the left side.

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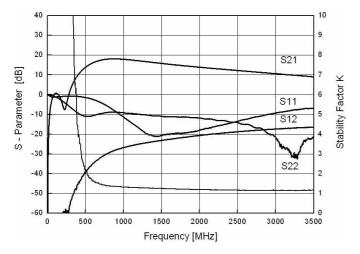


## Internally Matched LNA Module

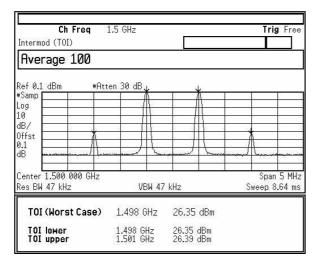




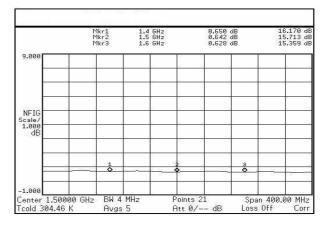
S-parameters & K Factor



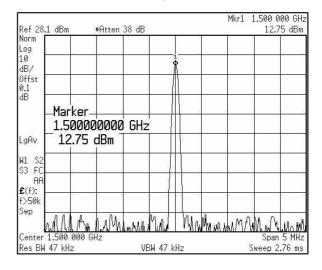
#### OIP3



**Noise Figure** 



P1dB



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ltem Voltage	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
4.5	-17.16	-9.28	16.10	0.84	0.643	10.70	24.14	21
4.6	-17.66	-9.36	16.14	0.85	0.621	11.12	24.85	22
4.7	-18.10	-9.42	16.17	0.83	0.622	11.60	25.37	23
4.8	-18.59	-9.47	16.19	0.85	0.627	11.91	25.66	24
4.9	-19.08	-9.52	16.21	0.84	0.627	12.52	26.34	25
5.0	-19.53	-9.57	16.23	0.84	0.636	12.76	26.81	26
5.1	-19.97	-9.59	16.25	0.84	0.632	13.19	27.25	27
5.2	-20.35	-9.63	16.27	0.84	0.620	13.54	27.77	28
5.3	-20.81	-9.64	16.28	0.84	0.627	13.99	27.94	30
5.4	-21.21	-9.68	16.30	0.85	0.634	14.27	28.51	31
5.5	-21.61	-9.68	16.31	0.85	0.631	14.49	28.59	32

## **RF Performance with Voltage Change**

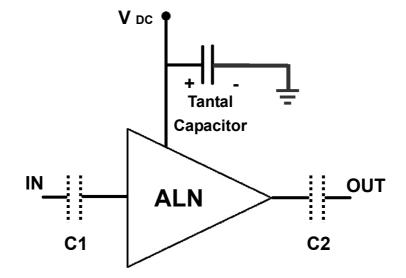
## **RF Performance with Operating Temperature**

ltem Temp.	S11 (dB)	S22 (dB)	S21 (dB)	G/F (dB)	NF (dB)	P1dB (dBm)	OIP3 (dBm)	Current (mA)
- 40°C	-19.68	-9.52	16.49	0.83	0.374	12.15	26.10	24
- 20°C	-19.68	-9.58	16.44	0.84	0.447	12.45	26.49	25
0°C	-19.70	-9.60	16.36	0.84	0.545	12.68	26.60	26
25°C	-19.75	-9.78	16.05	0.85	0.649	13.22	27.10	26
40°C	-19.54	-9.63	16.11	0.86	0.666	13.24	27.15	27
60°C	-19.29	-9.61	16.03	0.85	0.737	13.18	27.02	28
80°C	-19.05	-9.56	15.89	0.87	0.804	13.08	27.10	28
100°C	-18.76	-9.57	15.83	0.88	0.900	13.11	27.16	29



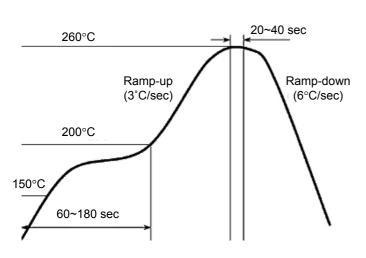
Internally Matched LNA Module

## **Application Circuit**

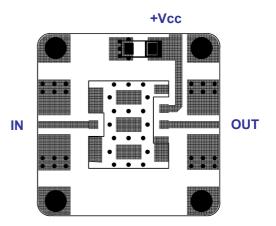


- The tantal capacitor is optional and for bypassing the AC noise introduced from the DC supply. The capacitance value may be determined by customer's DC supply status.
- 2) So-called DC blocking capacitors are always necessarily placed at the input and output port for allowing only the RF signal to pass and blocking the DC component in the signal. The DC blocking capacitors are included inside the LNA module. Therefore, C1 & C2 capacitors may not be necessary, but can be added just in case that the customer wants. The value of C1 & C2 is determined by considering the application frequency.

#### **Recommended Soldering Reflow Process**



### **Evaluation Board Layout**



Size 25 x 25mm (for ALN-AT, BT, T Series – 10x10mm)

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